

Product Specification [产品规格书]:	ISSUED BY:	Engineering Dept
Subject [主题]:	Date Issued	2021/05/10
1.00mm Pitch HRS-1038 Series Connector Specification	Date Revised	

This specification is referred to the 1.00mm series wire to board connector

# 索引【INDEX】

- 1. 适用范围 【Scope】
- 2. 规格与料号 【Spec and Part number】
- 3. 材质与表面处理 【Disposal of Material and surface】
- 4. 额定等级 【Ratings and applicable wires】
- 5. 性能 【 Performance 】
  - 5-1. 电气的性能【Electrical Performance.】
  - 5-2. 机械的性能【Mechanical Performance】
  - 5-3. 环境性能及其它【Environmental Performance and Others】
- 6. 综合插入力及拔出力 【 Insertion/Withdrawal Force 】
- 7. SMT 红外线回流条件 【 SMT Infrared Reflow Condition 】



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#### 【1.适用范围 Scope】

此种规格包括 1.00mm Pitch HRS-1038 Series 连接器规格说明.

This Specification Covers the 1.00mm Pitch HRS-1038 Series Connector Specification.

#### 【2.规格与料号 Spec and Part number】

规格内容	产品料号
Specification	Production No.
端子/Terminal	HRS-1038T-PXX
胶壳/Housing	HRS-1038H-2*XX-N0HF
针座/Wafer	HRS-1038WVS-2*XX-4TXX HRS-1038WRS-2*XX-4TXX

#### 【3.材质与表面处理 Disposal of Material and surface】

15.构灰马农画处理 Disposal of Material and Surface 2					
规格内容		材 质	表面处理		
Specification		Materials	Disposal of Surface		
端子/Terminal		磷铜/Phosphor Bronze	Gold Flash or 15u" . Nickel: Over $50\mu$ " .		
胶壳/Housing		PA66	UL 94V-0		
	Base	PA4T	UL 94V-0		
针座/Wafer	PIN	磷铜/Phosphor Bronze	Gold Flash or 15u" Min ; Over 50μ″ Nickel		
	Solder tab	黄铜/Brass	Over Matte Tin 100µ″ Plated Over 50µ″ Nickel		

## (上述参数请以工程图为准/Please Refer to the Project drawing for the above Specification)

#### 【4. 额定等级 Ratings and applicable wires】

项 目【Item】	规 格【Standard】		
额定电压 Rated Voltage (Max.)	50V	[40/00]	
额定电流 Rated Current (Max.)	1A	[AC/DC]	
使用温度范围 Ambient temperature Range	-25°C~+85°C		
适用线径 Applicable wire insulation O.D	AWG 28#、30#、32# Insulation O.D. 0.80mm(Max.)		

### 【 \*升温时含端子.Including terminal temperature rise. 】

WRITTEN BY: <u>Joshua</u> APPROVED BY: <u>lyl</u> Sheet: 2 of
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### 【5.性能 PERFORMANCE】

## 5-1. 电气的性能 Electrical Performance.

l	项 目 【Item】	条   件 【Test Condition】	规 格 【Requirement】
5-1-1	接触阻抗 Contact Resistance	公母配合,开放电压 20mV 以下,电流 10mA 检测连接器 A~B 区. Mate connectors, measure by dry circuit, 20mV MAX, 10mA. (Based upon EIA-364-06A).	Initial: 20 milliohms Max. After Test: 40 milliohms Max.
5-1-2	绝缘阻抗 Insulation Resistance	公母配合,在相邻端子,端子与地片之间,使用500V的直流电,检测连接器. Mate connectors, apply 500V DC between adjacent terminal or ground. (Based upon EIA-364-21B / MIL-STD-202 Method 302 Cond.B)	100 Megohms Min.
5-1-3	耐电压 Dielectric Strength	公母配合,在相邻端子,端子与地片之间,使用250V的交流电1分锺,检测连接器. Mate connectors, apply 250V AC for 1 minute between adjacent terminal or ground. (Based upon EIA-364-20A / MIL-STD-202 Method 301)	不出现中断等情况 No Breakdown and Flashover
5-1-4	铆线后端子接 触阻抗 Contact resistance on crimped portion	铆线后之端子,开放电压 20mV 以下,电流 10mA 检测连接器. Crimp the applicable wire on to the terminal measure by dry circuit 20mV MAX, 10mA.	10 milliohms Max.



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## 5-2. 机械的性能 Mechanical Performance.

	项 目 【Item】	条 件 【Test Condition】	规 格 【Requirement】
5-2-1	插拔力 Insertion & Retention Force	以每分锺 25.4±3mm 的速率插入和拔出. Insert and withdraw Connectors at the speed rate of 25.4±3mm/minute.	-
5-2-2	端子保持力 Terminal/ Housing Retention Force	以每分 25.4±3mm 的速率,将端子从 Housing 内轴向拔出的力量. Apply axial pull out force at the speed rate of 25.4±3mm/minute on the terminal assembled in the housing.	4.90N {0.5kgf} Min.
5-2-3	端子插入力 Terminal Insertion Force	铆线后之端子插入Housing所需最大力量. Insert the crimped terminal into the housing.	4.9N {0.5kgf} Max.
5-2-4	Pin 针保持力 Pin Retention Force	以每分 25.4±3mm 的速率,将 PIN 针从 Wafer 内轴向拔出的力量. Apply axial push force at the speed rate of 25.4±3mm/minute.	2.94N {0.30kgf} min.



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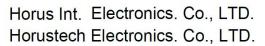
	项 目	条件	规	:	 格	
	[Item] [Test Condition]			irem	ent]	
		固定铆线后的端子, 使电线与端子分离时所	AWG#	#28	#30	#32
		需的最小力量.				
	—————————————————————————————————————	Fix the crimped terminal, apply axial pull ou	Spec.kgf.	1.0	0.5	0.3
	端子压着强度	force on the wire. (Do not crimp insulation	Min.	1.0	0.5	0.5
5-2-5	Tensile strength	part).				
(Crimped connections)		Contact Wire Pulling load	Note> As for sizes in thi define valu	s spec	cificati	ion

### 5-3. 环境性能及其它 Environmental Performance and Others.

项 目		条 件	规	格
[Item]		【Test Condition】	[Requirement]	
5-3-1	重复插拔 Repeated Insertion/ Withdrawal	以每分锺不超过 10 次的速率,将公母插拔30 次. When mated up to 30 cycles repeatedly by the rate of 10 cycles per minute.	接触阻抗 Contact Resistance	40 milliohms Max.
5-3-2	温升测试 Temperature Rise	公母对插后,在通过额定电流下,所测定的温度. Carrying rated current load. (UL 1977)	温升测试 Temperature rise	30°C Max.
	耐振动性 Vibration	振幅: 1.5mm P-P 时间: 10~55~10 HZ in 1 minute	外观 Appearance	无异状 No Damage
5-3-3		- '	接触阻抗 Contact Resistance	40 milliohms Max.
		(Based upon EIA-364-28B/MIL-STD-202 Method 213B Cond.A)	瞬断 Discontinuity	1 micro- second Max.
	耐冲击性 Shock	在 X.Y.Z 上 6 个方向上,以 490m/s <sup>2</sup> (50g 的	外观 Appearance	无异状 No Damage
5-3-4		力量)冲击下各 3 回.490m/s <sup>2</sup> {50G}, 3 strokes in each X.Y.Z. axes.	接触阻抗 Contact Resistance	40 milliohms Max.
		(Based upon EIA-364-27B/MIL-STD-202	<del>KCSIStarice</del> 瞬断	1 micro-
		Method 213B Cond.A)	Discontinuity	second Max.



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<b>一</b> 耐热性	85±2°⊂,96 hours.	外观 Appearance	无异状 No Damage
5-3-5	(Based upon MIL-STD-202 Method 108A Cond.A)	接触阻抗 Contact Resistance	40 milliohms Max.
耐寒性 5-3-6	-25±5°⊂,96 hours.	外观 Appearance 接触阻抗	无异状 No Damage
Cold Resistance	( Based upon EIA-364-105)	Contact Resistance	40 milliohms Max.
	温度: 40±2℃	外观 Appearance	无异状 No Damage
	湿度: 90~95%(RH) 持续时间: 96 hours	接触阻抗 Contact Resistance	40 milliohms Max.
5-3-7 Humidity	Temperature: 40±2°C Relative Humidity: 90~95%	耐电压 Dielectric Strength	Must meet 5-1-3
	Duration: 96 hours (Based upon EIA-364-31A/MIL-STD-202 Method 103B Cond.B)	绝缘阻抗 Insulation Resistance	100 Megohms Min.
	从-25℃持续 30 分锺升至+85℃持续 30 分锺,	外观 Appearance	无异状 No Damage
温度变化 5-3-8 Temperature Cycling	循环 5 次. 5 cycles of: a) -25° ⊂ 30 minutes. b) +85° ⊂ 30 minutes. (Based upon EIA-364-32B)	接触阻抗 Contact Resistance	40 milliohms Max.
5-3-9 盐水喷雾	在温度 35±2℃,盐水浓度 5±1%下,盐水喷雾 48±1 小时. 48±1 hours exposure to a salt spray from	Appearance	无异状 No Damage
Salt Spray	the 5±1% solution at 35±2°C. (Based upon EIA-364-26B/MIL-STD-202 Method 101D Cond.B).	接触阻抗 Contact Resistance	40 milliohms Max.
焊锡附着性 5-3-10 Solder- ability	焊接时间: 3~5 秒. 焊接温度: 245±5℃. Soldering Time: 3~5second. Solder Temperature: 245±5℃. (Based upon EIA-364-52)	Solder Wetting	浸渍面积需 95%以上 95% of immersed area must show no voids, pin holes.
WRITTEN BY: Jo	shua APPROVED B	Y: <u>lyl</u>	Sheet: 6 of 7





Subject [主题]:     1.00mm Pitch HRS-1038 Series Connector Specification	Product Specification [产品规格书]:	ISSUED BY:	Engineering Dept
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WRITTEN BY: Joshua APPROVED BY: Iyl Sheet: 7 of 7



Product Specification [产品规格书]:	ISSUED BY: Engineering Dept	
Subject [主题]:	Date Issued	2021/05/10
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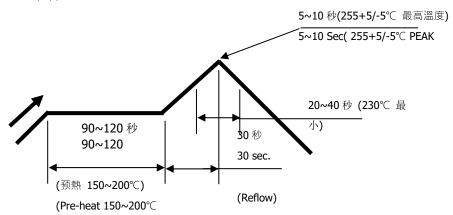
	项 目	条   件	规	格
	【Item】	【Test Condition】	【Require	ement】
5-3-11		焊接时间: 5~10 秒. 焊接温度: 255+5/-5℃. Soldering time:5~10 sec solder. Temperature:255+5/-5℃. (Based upon EIA-364-56A)	外观 Appearance	无异状 No Damage

#### 【6.综合插入力及拔出力 INSERTION/WITHDRAWAL FORCE】 < Connector mating force >

PIN 数 No. of CKT	初次插入力(最大值) First Insertion (kgf Max.)	30 次拔出力(最小值) 30 <sup>th</sup> Withdrawal (kgf Min.)	PIN 数 No. of CKT	初次插入力(最大值) First Insertion (kgf Max.)	30 次拔出力(最小值) 30 <sup>th</sup> Withdrawal (kgf Min.)
2*08	2.40	0.30	2*15	4.50	0.50
2*10	3.00	0.35	2*20	6.00	0.60
2*12	3.60	0.40	2*25	7.50	0.80

注: 以上插拔次数为 30 次 Note: Insertion and Withdrawal for 30Cycles

#### 【7. SMT 回流条件 SMT REFLOW CONDITION】



温度条件曲线图/ 基板上温度

## TEMPERATURE CONDITION GRAPH/ (TEMPERATURE ON BOARD PATTERN SIDE)

注记: 由于 P.C 板等焊接装置改变条件,所以请预先用自己的装置检查回流焊的条件.

Notes: Please check the reflow soldering condition by your own devices beforehand. Because the condition changes by the soldering devices, P.C. boards, and so on.